





Certificate of Registration

OCCUPATIONAL HEALTH & SAFETY MANAGEMENT SYSTEM - ISO 45001:2018

This is to certify that:

Ardentec Corporation

No. 3, Gongye 3rd Rd. Hukou Township Hsinchu County

303036 Taiwan 欣銓科技股份有限公司

臺灣 新竹縣 湖口鄉

工業三路3號 303036

Holds Certificate No:

OHS 693306

and operates an Occupational Health and Safety Management System which complies with the requirements of ISO 45001:2018 for the following scope:

1. The manufacture of WLCSP (Wafer Level Chip Scale Package) and semiconductor device trimming.

2. The production testing of semiconductor device.

[Previously certified to BS OHSAS 18001:2007 since 2007-08-01]

For and on behalf of BSI:

Michael Lam - Managing Director Assurance, APAC

Original Registration Date: 2018-07-25

Latest Revision Date: 2024-06-18

Effective Date: 2024-07-25 Expiry Date: 2027-07-24

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...making excellence a habit."

This certificate was issued electronically and remains the property of BSI and is bound by the conditions of contract. An electronic certificate can be authenticated <u>online</u>.

Printed copies can be validated at www.bsi-global.com/ClientDirectory or telephone +886 (02)2656-0333.

Certificate No:

OHS 693306

Location

Registered Activities

The production testing of semiconductor device.

Ardentec Corporation TingShin Site

No. 3, 3-1, Gongye 3rd Rd.

Shengli Vil.

Hukou Township

Hsinchu County

303036

Taiwan

欣銓科技股份有限公司 新工一廠

臺灣

新竹縣

湖口鄉

工業三路3號, 3-1號

303036

Ardentec Corporation Kaiyuan Site

No. 24, Wenhua Rd. Hukou Township

Hsinchu County

303035

Taiwan

欣銓科技股份有限公司 新工二廠

臺灣

新竹縣

湖口鄉

文化路24號

303035

The manufacture of WLCSP (Wafer Level Chip Scale Package) and semiconductor device trimming.

Ardentec Corporation Gaosheng Site

No. 9, Renyi Rd.

Hukou Township

Hsinchu County

303035

Taiwan

欣銓科技股份有限公司 新工三廠

臺灣

新竹縣

湖口鄉

仁義路9號

303035

The production testing of semiconductor device.

Original Registration Date: 2018-07-25 Latest Revision Date: 2024-06-18 Effective Date: 2024-07-25 Expiry Date: 2027-07-24

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Certificate No:

OHS 693306

Location

Registered Activities

Ardentec Corporation Paoching Site

1F, 6F, 7F

No. 12, Guangfu N. Rd.

Hukou Township

Hsinchu County

303036

Taiwan

欣銓科技股份有限公司 新工五廠

臺灣

新竹縣

湖口鄉

光復北路12號

1、6、7樓

303036

The production testing of semiconductor device.

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Taiwan Headquarters: 2nd Floor, No.37, Ji-Hu Rd., Nei-Hu Dist., Taipei 114, Taiwan, R.O.C. A Member of the BSI Group of Companies.